

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5369294

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
CAYUGA VENTURE FUND IV, LP	01/18/2019
RECEIVING PARTY DATA	
Name:	PRIMET PRECISION MATERIALS, INC.
Street Address:	950 DANBY ROAD
City:	ITHACA
State/Country:	NEW YORK
Postal Code:	14850
PROPERTY NUMBERS Total: 15	
Property Type	Number
Patent Number:	7140567
Patent Number:	7213776
Patent Number:	7329303
Patent Number:	7416141
Patent Number:	7267292
Patent Number:	7665678
Patent Number:	7578457
Application Number:	11193688
Application Number:	11318341
Patent Number:	8377509
Application Number:	13718848
Application Number:	12342043
Application Number:	12868933
Application Number:	12605050
Patent Number:	8643027
CORRESPONDENCE DATA	
Fax Number:	(585)232-2152
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5852326500

Email: patent@hselaw.com
Correspondent Name: HARTER SECREST & EMERY LLP
Address Line 1: 1600 BAUSCH & LOMB PLACE
Address Line 4: ROCHESTER, NEW YORK 14604-2711

ATTORNEY DOCKET NUMBER:	092771-10
NAME OF SUBMITTER:	JODI A. REYNOLDS
SIGNATURE:	/JODI A. REYNOLDS/
DATE SIGNED:	02/11/2019

Total Attachments: 19

source=92771-10_Release_Security_Agreements_Cay_to_Primet#page1.tif
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source=92771-10_Release_Security_Agreements_Cay_to_Primet#page16.tif
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source=92771-10_Release_Security_Agreements_Cay_to_Primet#page18.tif
source=92771-10_Release_Security_Agreements_Cay_to_Primet#page19.tif

RELEASE OF SECURITY INTEREST

This RELEASE OF SECURITY INTEREST (the “**Release**”), is made and is effective as of January 18, 2019 by CAYUGA VENTURE FUND IV, LP, a Delaware limited partnership with a principal place of business located at Cornell Business & Tech Park, 15 Thornwood Drive, Ithaca, New York 14850 (“**Secured Party**”) for PRIMET PRECISION MATERIALS, INC., a Delaware corporation with a principal place of business located at 950 Danby Road, Ithaca, New York 14850 (“**Debtor**”).

WHEREAS, Debtor and Secured Party entered into a Security Agreement dated as of August 27, 2013 (the “**2013 Security Agreement**”), whereby Debtor granted to Secured Party a security interest in the collateral described in Exhibit A (the “**2013 Collateral**”), as security for the Obligations; and

WHEREAS, the 2013 Security Agreement was recorded (a) at Reel 031105/Frame 0912 on August 28, 2013 at the United States Patent Office, and (b) at Reel 5099/Frame 0402 on August 28, 2013 at the United States Trademark Office; and

WHEREAS, Debtor and Secured Party entered into a Security Agreement dated as of May 23, 2014 (the “**2014 Security Agreement**”), whereby Debtor granted to Secured Party a security interest in the collateral described in Exhibit B (the “**2014 Collateral**”), as security for the Obligations; and

WHEREAS, the 2014 Security Agreement was recorded at Reel 033193/Frame 0047 on June 18, 2014 at the United States Patent Office; and

WHEREAS, Debtor has satisfied the Obligations and Secured Party desires to release its security interest in the 2013 Collateral and to terminate the 2013 Security Agreement; and

WHEREAS, Debtor has satisfied the Obligations and Secured Party desires to release its security interest in the 2014 Collateral and to terminate the 2014 Security Agreement.

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Secured Party hereby agrees as follows:

1. Defined Terms. Capitalized terms used herein without definition have the respective meanings provided therefor in the 2013 Security Agreement or the 2014 Security Agreement, as applicable.
2. Termination of 2013 Security Agreement and Release of Security Interest. Secured Party hereby (a) terminates the 2013 Security Agreement, (b) terminates, releases and discharges all security interests and liens in the 2013 Collateral, and (c)

reassigns to Debtor all right, title, and interest that Secured Party may have in, to, or under the 2013 Collateral. Secured Party hereby authorizes Debtor (and its legal counsel), without further notice, to file all security interest or lien releases, including, without limitation, Uniform Commercial Code financing statement releases or terminations, that are necessary to release all security interests and liens that Debtor has granted to Secured Party under the 2013 Security Agreement, without the signature of Secured Party, to the extent permitted by applicable law.

3. Termination of 2014 Security Agreement and Release of Security Interest. Secured Party hereby (a) terminates the 2014 Security Agreement, (b) terminates, releases and discharges all security interests and liens in the 2014 Collateral, and (c) reassigns to Debtor all right, title, and interest that Secured Party may have in, to, or under the 2014 Collateral. Secured Party hereby authorizes Debtor (and its legal counsel), without further notice, to file all security interest or lien releases, including, without limitation, Uniform Commercial Code financing statement releases or terminations, that are necessary to release all security interests and liens that Debtor has granted to Secured Party under the 2014 Security Agreement, without the signature of Secured Party, to the extent permitted by applicable law.

4. Recordation. Secured Party hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to note and record the existence of the releases hereby given.

[SIGNATURE PAGE FOLLOWS]

IN WITNESS WHEREOF, Secured Party has caused this Release to be duly executed and delivered as of the date first above written.

CAYUGA VENTURE FUND IV, LP

By: CVF Partners IV, LLC, its
General Partner

A handwritten signature in black ink, appearing to read 'ZS', is written over a light gray, textured rectangular background.

By: _____

Name: Zachary Shulman

Title: Member

EXHIBIT A
2013 SECURITY AGREEMENT LIST OF COPYRIGHTS, PATENTS AND
TRADEMARKS

1. U.S. Patent No. 7,140,567
Issued: 11/28/2006
Based on U.S. Patent Application Serial No.: 10/797,343
Filed: 03/10/04
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
2. African Patent No. AP 212
Issued: 06/03/10
Based on African Patent No. AP 212
Issued: 06/03/10
Based on African Regional Patent Application Serial No. AP/P/2005/003416
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
3. Australian Patent No. 2004247623
Issued: 01/22/09
Based on Australian Patent Application Serial No.: 2004247623
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
4. Brazilian Patent Application Serial No. PI04082788
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
5. Canadian Patent Application Serial No. 2518851
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
6. Chinese Patent No. ZL200480006402.7
Issue Date: 07/02/08
Based on Chinese Patent Application Serial No. 200480006402.7
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
7. European Patent No. 1615746
Issue Date: 06/25/08
Based on European Patent Application Serial No. 04749362.2
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
Validated in: Austria, Switzerland, Germany, France, Great Britain, Netherlands

8. Indian Patent No. 223850
Issue Date: 09/23/08
Based on Indian Patent Application Serial No.: 1992/KOLNP/2005
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
9. Japanese Patent No. 4755101
Issue Date: 06/03/11
Based on Japanese Patent Application Serial No. 2006-532319
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
10. Korean Patent No. 10-1179809
Issue Date: 08/29/12
Based on Korean Patent Application Serial No. 10-2005-7016806
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
11. Mexican Patent No. 275294
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
12. New Zealand Patent No. 542844
Issued: 03/12/09
Based on New Zealand Patent Application Serial No.: 542844
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
13. U.S. Patent No. 7,213,776
Issued: 05/08/07
Based on U.S. Patent Application Serial No.: 11/035,492
Filed: 01/14/2005
Title: METHOD OF MAKING PARTICLES OF AN INTERMETALLIC COMPOUND
14. U.S. Patent No. 7,329,303
Issue Date: 02/12/08
Based on U.S. Patent Application Serial No.: 11/035,984
Filed: 01/14/2005
Title: METHODS OF PRODUCING TITANIUM METAL USING MULTI-CARBIDE GRINDING MEDIA

15. U.S. Patent No. 7,416,141
Issue Date: 08/26/08
Based on U.S. Patent Application Serial No.: 11/036,228
Filed: 01/14/2005
Title: METHOD FOR PRODUCING DIAMOND PARTICLES USING MULTI-CARBIDE GRINDING MEDIA
16. U.S. Patent No. 7,267,292
Issued: 09/11/07
Based on U.S. Patent Application Serial No.: 11/035,490
Filed: 01/15/2005
Title: METHOD FOR PRODUCING FINE ALUMINA PARTICLES USING MULTI-CARBIDE GRINDING MEDIA
17. U.S. Patent No. 7,665,678
Issued: 02/23/10
Patent Application Serial No.: 11/035,455
Filed: 01/14/2005
Title: METHOD FOR PRODUCING FINE DENITRIDED METAL PARTICLES USING MULTI-CARBIDE GRINDING MEDIA
18. U.S. Patent No. 7,578,457
Issued: 08/25/09
Application Serial No.: 11/035,454
Filed: 01/14/2005
Title: METHOD FOR PRODUCING FINE DEHYDRIDED METAL PARTICLES USING MULTI-CARBIDE GRINDING MEDIA
19. U.S. Patent Application Serial No.: 11/193,688
Filed: 07/29/2005
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME
20. Australian Patent No. 2006275742
Issued: 12/23/10
Application Serial No. 2006275742
Filed: 07/28/06
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME
21. Brazilian Patent Application Serial No. PI0614613-9
Filed: 07/28/06
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

22. Canadian Patent No. 2617091

Issue Date: 05/21/13

Based on Canadian Patent Application Serial No. 2617091

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

23. Chinese Patent No. ZL200680031858.8

Issue Date: 01/25/12

Based on Chinese Patent Application Serial No. 200680031858.8

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

24. European Patent No. 1915327

Issued: 12/09/09

Based on Application Serial No. 06788745.52111

Filed 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

Validated in: Switzerland, Germany, France, Great Britain, Netherlands, Spain

25. Indian Patent Application Serial No. 1418/DELNP/2008

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

26. Japanese Patent No. 5073658

Issue Date: 08/31/12

Based on Japanese Patent Application Serial No. 2008-524175

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

27. Korean Patent Application Serial No. 10-2008-7004791

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

28. U.S. Patent Application Serial No.: 11/318,341

Filed: 12/23/05

Title: SMALL PARTICLE COMPOSITIONS AND ASSOCIATED METHODS

29. Japanese Patent Application Serial No. 2008-538050
Filed: 10/26/06
Title: SMALL PARTICLE COMPOSITIONS AND ASSOCIATED METHODS
30. U.S. Patent Application Serial No.: 11/634,520
Filed: 12/06/2006
Title: MILLED PARTICLE COMPOSITIONS AND RELATED METHODS AND STRUCTURES
31. U.S. Patent No. 8,377,509
Issue Date: 02/19/13
Based on U.S. Patent Application No.: 11/712,831
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
32. U.S. Patent Application No. 13/718,848
Filed: 12/18/12
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
33. Chinese Patent Application Serial No. 200780015296.2
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
34. Chinese Patent Application No. 201310308751.5
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
35. European Patent Application Serial No. 07752131.8
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
36. European Patent Application Serial No. 12153609.8
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

37. Japanese Patent Application Serial No. 2008-557411
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
38. Korean Patent Application Serial No. 10-2008-7023424
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
39. U.S. Patent Application Serial No.: 12/342,043
Filed: 12/22/08
Title: SMALL PARTICLE ELECTRODE MATERIAL COMPOSITIONS AND METHODS OF FORMING THE SAME
40. Chinese Patent Application Serial No.: 200880127142.7
Filed: 12/22/08
Title: SMALL PARTICLE ELECTRODE MATERIAL COMPOSITIONS AND METHODS OF FORMING THE SAME
41. European Patent Application Serial No.: 08864893.6
Filed: 12/22/08
Title: SMALL PARTICLE ELECTRODE MATERIAL COMPOSITIONS AND METHODS OF FORMING THE SAME
42. Japanese Patent Application Serial No.: 2010-539521
Filed: 12/22/08
Title: SMALL PARTICLE ELECTRODE MATERIAL COMPOSITIONS AND METHODS OF FORMING THE SAME
43. Korean Patent Application Serial No.: 10-2010-7016334
Filed: 12/22/08
Title: SMALL PARTICLE ELECTRODE MATERIAL COMPOSITIONS AND METHODS OF FORMING THE SAME
44. U.S. Patent Application Serial No.: 12/868,933
Filed: 08/26/10
Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME
45. Chinese Patent Application Serial No. 201080043373.7
Filed: 08/26/10
Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME

46. European Patent Application Serial No. 10812432.2
Filed: 08/26/10
Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME
47. Japanese Patent Application Serial No. 2012-526730
Filed: 08/26/10
Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME
48. Korean Application No. 10-2012-7007816
Filed: 08/26/10
Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME
49. U.S. Patent Application Serial No.: 12/605,050
Filed: 10/23/09
Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
50. Chinese Application No. 200980147034.0
Filed: 10/23/09
Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
51. European Application No. 09822338.1
Filed: 10/23/09
Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
52. Korean Application No. 10-2011-7011643
Filed: 10/23/09
Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
53. Japanese Application No. 2011-533185
Filed: 10/23/09
Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
54. U.S. Trademark Registration No. 3942024Mark: NANOSCISSION
Classes: 001, 040, 042
Date of Registration: April 5, 2011
55. U.S. Trademark Application No. 77/670,198
Mark: NANOSCISSION
Class: 007
56. Community Trademark Registration No. 008482631
Mark: NANOSCISSION
Classes: 001, 007, 040
Date of Registration: March 22, 2010

57. Canadian Trademark Application No. 1446766
Mark: NANOSCISSION
Class: N/A

58. Chinese Trademark Registration No. 7613151
Mark: NANOSCISSION
Class: 040
Date of Registration: January 21, 2011

59. Japanese Trademark Registration No. 5426984
Mark: NANOSCISSION
Class: 001
Date of Registration: July 22, 2011

EXHIBIT B
2014 SECURITY AGREEMENT LIST OF COPYRIGHTS, PATENTS AND
TRADEMARKS

1. U.S. Patent No. 7,140,567
Issued: 11/28/2006
Based on U.S. Patent Application Serial No.: 10/797,343
Filed: 03/10/04
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
2. African Patent No. AP 2127
Based on African Patent No. AP 212
Issued: 06/03/10
Based on African Regional Patent Application Serial No. AP/P/2005/003416
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
3. Australian Patent No. 2004247623
Issued: 01/22/09
Based on Australian Patent Application Serial No.: 2004247623
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
4. Brazilian Patent Application Serial No. PI04082788
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
5. Canadian Patent No. 2518851
Issue Date: 1/21/14
Based on Canadian Patent Application Serial No. 2518851
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
6. Chinese Patent No. ZL200480006402.7
Issue Date: 07/02/08
Based on Chinese Patent Application Serial No. 200480006402.7
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
7. European Patent No. 1615746
Issue Date: 06/25/08
Based on European Patent Application Serial No. 04749362.2
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
Validated in: Austria, Switzerland, Germany, France, Great Britain, Netherlands

8. Indian Patent No. 223850
Issue Date: 09/23/08
Based on Indian Patent Application Serial No. : 1992/KOLNP/2005
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
9. Japanese Patent No. 4755101
Issue Date: 06/03/11
Based on Japanese Patent Application Serial No. 2006-532319
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
10. Korean Patent No. 10-1179809
Issue Date: 08/29/12
Based on Korean Patent Application Serial No. 10-2005-7016806
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Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
11. Mexican Patent No. 275294
Issued: 04/19/2010
Based on Mexican Patent Application Serial No. PA/a/2005/009610
Filed: 3/10/2004
Title: MULTI-CARBIDE MATERIAL MANUFACTURE AND USE
12. New Zealand Patent No. 542844
Issued: 03/12/09
Based on New Zealand Patent Application Serial No.: 542844
Filed: 3/10/2004
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16. U.S. Patent No. 7,267,292
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Based on U.S. Patent Application Serial No.: 11/035,490
Filed: 01/15/2005
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Patent Application Serial No.: 11/035,455
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18. U.S. Patent No. 7,578,457
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Application Serial No.: 11/035,454
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Title: METHOD FOR PRODUCING FINE DEHYDRIDED METAL PARTICLES USING MULTI-CARBIDE GRINDING MEDIA
19. U.S. Patent Application Serial No.: 11/193,688
Filed: 07/29/2005
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME
20. Australian Patent No. 2006275742
Issued: 12/23/10
Based on Australian Patent Application Serial No. 2006275742
Filed: 07/28/06
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME
21. Brazilian Patent Application Serial No. PI0614613-9
Filed: 07/28/06
Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

22. Canadian Patent No. 2617091

Issue Date: 05/21/13

Based on Canadian Patent Application Serial No. 2617091

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

23. Chinese Patent No. ZL200680031858.8

Issue Date: 01/25/12

Based on Chinese Patent Application Serial No. 200680031858.8

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

24. European Patent No. 1915327

Issued: 12/09/09

Based on Application Serial No. 06788745.52111

Filed 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

Validated in: Switzerland, Germany, France, Great Britain, Netherlands, Spain

25. Indian Patent Application Serial No. 1418/DELNP/2008

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

26. Japanese Patent No. 5073658

Issue Date: 08/31/12

Based on Japanese Patent Application Serial No. 2008-524175

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

27. Korean Patent No. 10-1327713

Issued: 11/04/13

Korean Patent Application Serial No. 10-2008-7004791

Filed: 07/28/06

Title: GRINDING MEDIA COMPOSITIONS AND METHODS ASSOCIATED WITH THE SAME

28. U.S. Patent Application Serial No.: 11/318,341
Filed: 12/23/05
Title: SMALL PARTICLE COMPOSITIONS AND ASSOCIATED METHODS
29. Japanese Patent Application Serial No. 2008-538050
Filed: 10/26/06
Title: SMALL PARTICLE COMPOSITIONS AND ASSOCIATED METHODS
30. U.S. Patent No. 8,643,027
Issue Date: 2/4/14
Based on U.S. Patent Application Serial No.: 11/634,520
Filed: 12/06/2006
Title: MILLED PARTICLE COMPOSITIONS AND RELATED METHODS AND STRUCTURES
31. U.S. Patent No. 8,377,509
Issue Date: 02/19/13
Based on U.S. Patent Application No.: 11/712,831
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
32. U.S. Patent Application No. 13/718,848
Filed: 12/18/12
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
33. Chinese Patent Application Serial No. 200780015296.2
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
34. Chinese Patent Application No. 201310308751.5
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME
35. Japanese Application No. 2013-214561
Filed: 02/28/07
Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

36. Korean Application No. 10-2013-7021977

Filed: 02/28/07

Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

37. European Patent Application Serial No. 07752131.8

Filed: 02/28/07

Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

38. European Patent Application Serial No. 12153609.8

Filed: 02/28/07

Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

39. Japanese Patent No. 5466408

Issue Date: 1/31/14

Based on Japanese Patent Application Serial No. 2008-557411

Filed: 02/28/07

Title: LITHIUM-BASED COMPOUND NANOPARTICLE COMPOSITIONS AND METHODS OF FORMING THE SAME

40. Korean Patent No. 10-1336566

Issue Date: 11/27/13

Korean Patent Application Serial No. 10-2008-7023424

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Title: COMPOSITIONS AND PROCESSES FOR MAKING THE SAME
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52. Chinese Patent Application Serial No. 200980147034.0
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Title: GROUP IVA SMALL PARTICLE COMPOSITIONS AND RELATED METHODS
53. European Patent Application Serial No.: 09822338.1
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